

MOSFET MODULE Dual 30A 450V/500V
PD4M441H / PD4M440H
FEATURES

- * Dual MOS FETs Cascaded Circuit
- * Prevented Body Diodes of MOSFETs by SBDs, and Ultra Fast Recovery Diodes Connected in Parallel
- * 300KHz High Speed Switching Possible

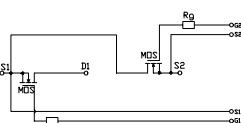
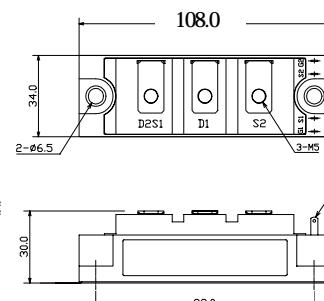
TYPICAL APPLICATIONS

- * Power Supply for the Communications and the Induction Heating

OUTLINE DRAWING

Dimension(mm)

Circuit

Approximate Weight : 220g

MAXMUM RATINGS

Ratings		Symbol	PD4M441H	PD4M440H	Unit	
Drain-Source Voltage (V _{GS} =0V)		V _{DSS}	450	500	V	
Gate - Source Voltage		V _{GSS}	+/- 20		V	
Continuous Drain Current	Duty=50%	I _D	30 (T _c =25°C)	21 (T _c =25°C)	A	
	D.C.					
Pulsed Drain Current		I _{DM}	60 T _c =25°C	A		
Total Power Dissipation		P _D	230 T _c =25°C	W		
Operating Junction Temperature Range		T _{JW}	-40 to +150	°C		
Storage Temperature Range		T _{Sg}	-40 to +125	°C		
Isolation Voltage Terminals to Base AC, 1 min.)		V _{ISO}	2000	V		
Mounting Torque	Module Base to Heatsink	F _{TOR}	3.0	2.0	Nm	
	Bus Bar to Main Terminals					

ELECTRICAL CHARACTERISTICS (@T_c=25°C unless otherwise noted)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} =V _{DSS} , V _{GS} =0V	-	-	1.0	mA
		T _j =125°C, V _{DS} =V _{DSS} , V _{GS} =0V	-	-	4.0	
Gate-Source Threshold Voltage	V _{GS(th)}	V _{DS} =V _{GS} , I _D =1mA	2.0	3.2	4.0	V
Gate-Source Leakage Current	I _{GSS}	V _{GS} =+/- 20V, V _{DS} =0V	-	-	1.0	μA
Static Drain-Source On-Resistance	R _{DSS(on)}	V _{GS} =10V, I _D =15A	-	190	210	m-ohm
Drain-Source On-Voltage	V _{DS(on)}	V _{GS} =10V, I _D =15A	-	3.3	3.5	V
Forward Transconductance	g _f	V _{DS} =15V, I _D =15A	-	27	-	S
Input Capacitance	C _{ies}	V _{DS} =25V, V _{GS} =0V, f=1MHz	-	5.2	-	nF
Output Capacitance	C _{oss}		-	1.1	-	nF
Reverse Transfer Capacitance	C _{iss}		-	0.18	-	nF
Turn-On Delay Time	t _{d(on)}	V _{DD} = 1/2V _{DSS} I _D =15A V _{GS} = -5V, +10V R _G = 7ohm	-	100	-	ns
Rise Time	t _r		-	60	-	
Turn-Off Delay Time	t _{d(off)}		-	180	-	
Fall Time	t _f		-	50	-	

FREE WHEELING DIODES RATINGS & CHARACTERISTICS (T_c=25°C)

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Continuous Source Current	I _S	D.C.	-	-	21	A
Pulsed Source Current	I _{SM}	-	-	-	60	A
Diode Forward Voltage	V _{SD}	I _S =30A	-	-	1.8	V
Reverse Recovery Time	t _{rr}	I _S =30A, -dI/dt=100A/μs	-	100	-	ns
Reverse Recovery	Q _r		-	0.15	-	μC

THERMAL CHARACTERISTICS

Characteristic	Symbol	Test Condition	Min.	Typ.	Max.	Unit
Thermal Resistance, Junction to Case	R _{th(j)}	MOS FET	-	-	0.56	°C/W
		Diode	-	-	2.0	
Thermal Resistance, Case to Heatsink	R _{th(c)}	Mounting surface flat, smooth, and greased	-	-	0.1	

PD4M44xH

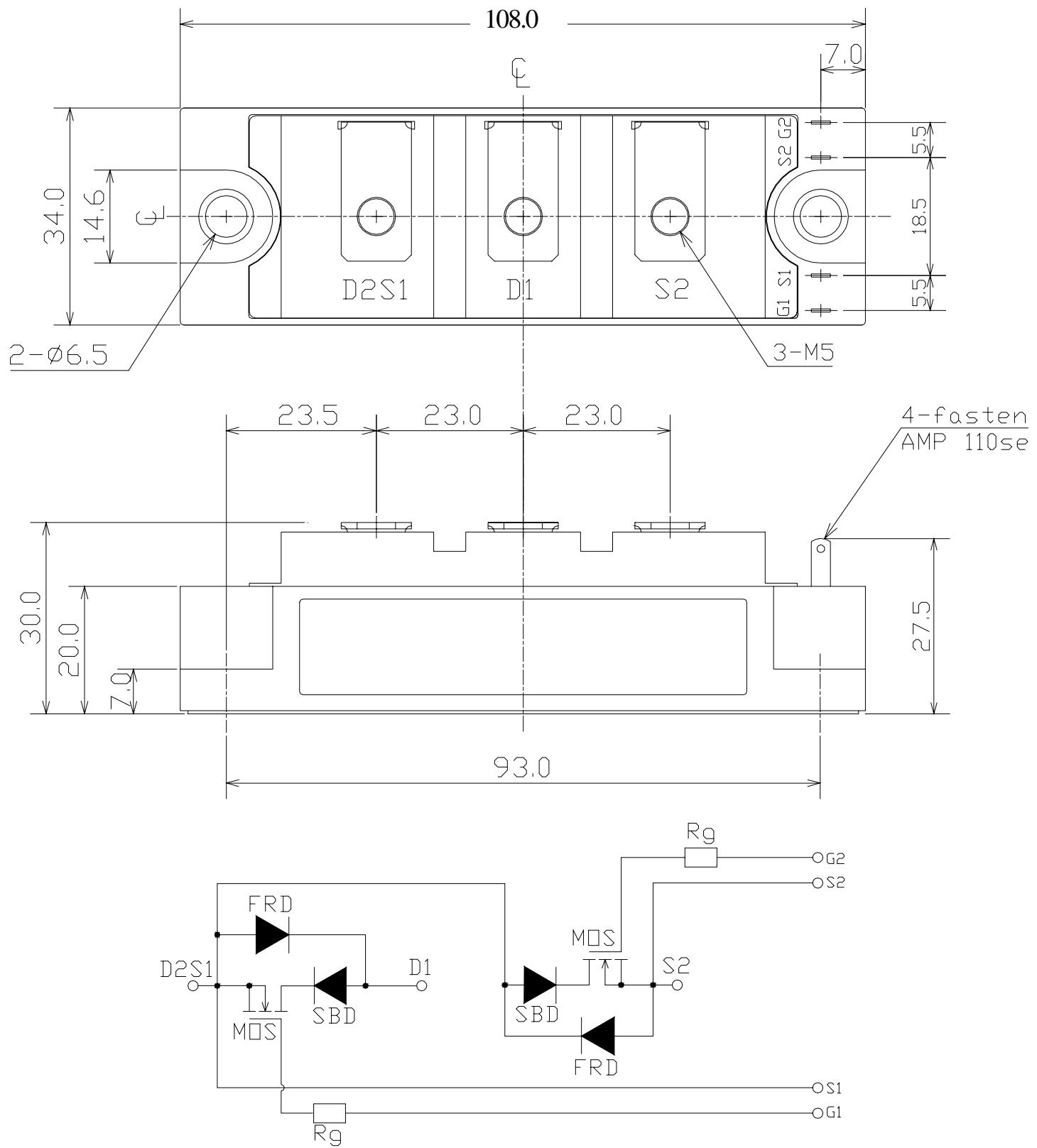


Fig. 1 Typical Output Characteristics

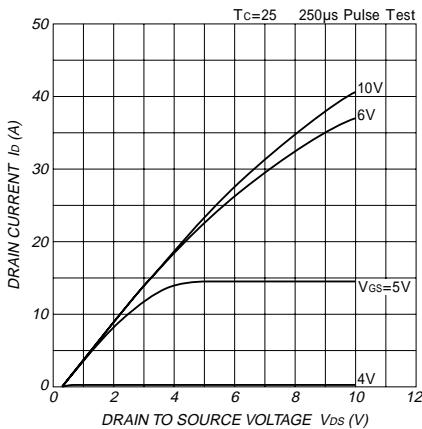


Fig. 4 Typical Capacitance Vs. Drain-Source Voltage

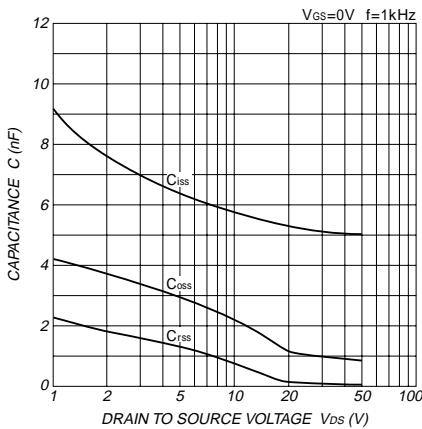


Fig. 7 Typical Switching Time Vs. Drain Current

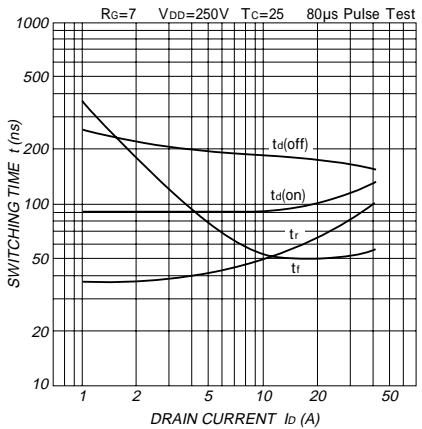


Fig. 10 Maximum Safe Operating Area

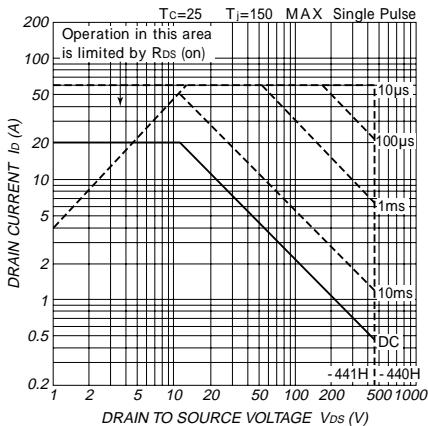


Fig. 2 Typical Drain-Source On-Voltage Vs. Gate-Source Voltage

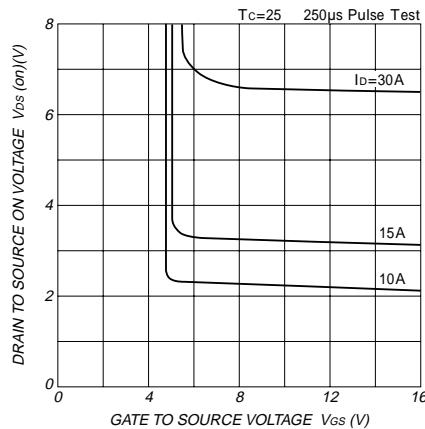


Fig. 5 Typical Gate Charge Vs. Gate-Source Voltage

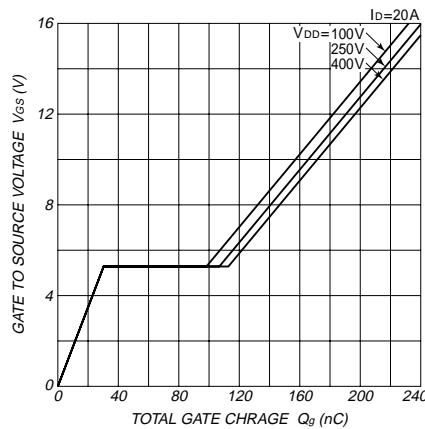


Fig. 8 Typical Source-Drain Diode Forward Characteristics

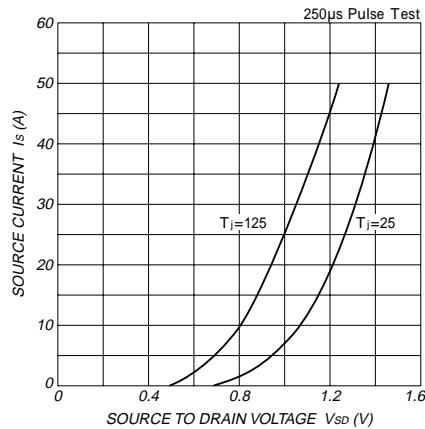


Fig. 11-1
Normalized Transient Thermal impedance(MOSFET)

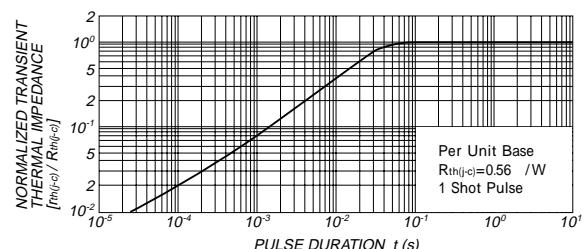


Fig. 11-2
Normalized Transient Thermal impedance(DIODE)

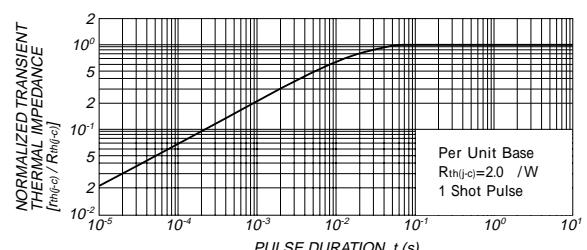


Fig. 3 Typical Drain-Source On Voltage Vs. Junction Temperature

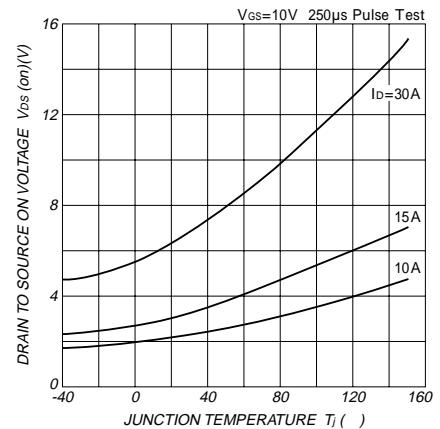


Fig. 6 Typical Switching Time Vs. Series Gate impedance

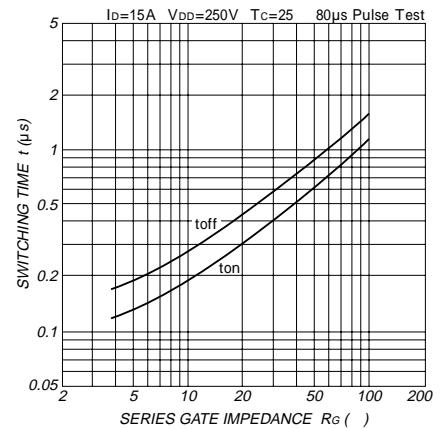


Fig. 9 Typical Reverse Recovery Characteristics

